



# 60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8 (SWP) (Type UX)

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>C</sub> = +25°C
	16mΩ @ V <sub>GS</sub> = 10V	41A
60V	$27m\Omega @ V_{GS} = 4.5V$	31.6A

#### **Features and Benefits**

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Small form factor thermally efficient package enables higher density end products
- Wettable Flank for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Description and Applications**

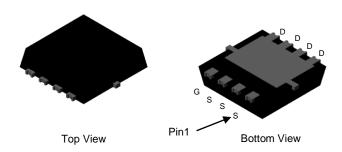
This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

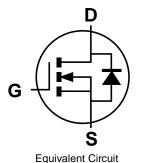
- Backlighting
- Power Management Functions
- DC-DC Converters

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8 (SWP) (Type UX)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 <sup>3</sup>
- Weight: 0.072 grams (Approximate)

PowerDI3333-8 (SWP) (Type UX)





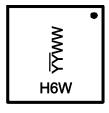
### Ordering Information (Note 5)

Part Number	Case	Packaging
DMTH6016LFVWQ-7	PowerDI3333-8 (SWP) (Type UX)	2,000/Tape & Reel
DMTH6016LFVWQ-13	PowerDI3333-8 (SWP) (Type UX)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



H6W = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 18 = 2018)

WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage	$V_{GSS}$	±20	V	
Continuous Drain Current (Note 8) V <sub>GS</sub> = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I <sub>D</sub>	41 29	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	160	Α	
Maximum Continuous Body Diode Forward Current (Note 8)	Is	33	Α	
Pulsed Body Diode Forward Current (Note 8)	I <sub>SM</sub>	160	Α	
Avalanche Current, L = 0.1mH (Note 9)	I <sub>AS</sub>	16	Α	
Avalanche Energy, L = 0.1mH (Note 9)	E <sub>AS</sub>	12.8	mJ	

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 6)	$P_{D}$	1.17	W		
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	128	°C/W	
Total Power Dissipation (Note 7)		P <sub>D</sub>	2.38	W	
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	$R_{ heta JA}$	63	°C/W	
Thermal Resistance, Junction to Case (Note 8)		$R_{ heta JC}$	3.7	C/VV	
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +175	°C	

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 10)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			1	μA	V <sub>DS</sub> = 48V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>			±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 10)				•	•		
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	D	_	12.3	16	0	$V_{GS} = 10V, I_D = 20A$	
Static Diani-Source On-Resistance	R <sub>DS(ON)</sub>	_	20.3	27	mΩ	$V_{GS} = 4.5V, I_D = 18A$	
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	$V_{GS} = 0V$ , $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 11)						•	
Input Capacitance	$C_{iss}$	_	939	_		$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Output Capacitance	Coss	_	270	_	pF		
Reverse Transfer Capacitance	Crss	_	23.4	_			
Gate Resistance	Rg	_	1.4	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_{g}$	_	7.3	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	15.1	_	nC	$V_{DS} = 30V, I_D = 10A$	
Gate-Source Charge	$Q_{gs}$	_	2.5	_	IIC		
Gate-Drain Charge	$Q_{gd}$	_	3.5	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.9	_		$V_{GS} = 10V, V_{DS} = 30V,$ $R_G = 6\Omega, I_D = 10A$	
Turn-On Rise Time	t <sub>R</sub>	_	6.3	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	14.3	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	5.9	_			
Reverse Recovery Time	t <sub>RR</sub>	_	22	_	ns	1 400 4:/44 4000/	
Reverse Recovery Charge	Q <sub>RR</sub>	_	12	_	nC	$I_F = 10A$ , di/dt = 100A/ $\mu$ s	

Notes:

<sup>6.</sup> Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.7. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.

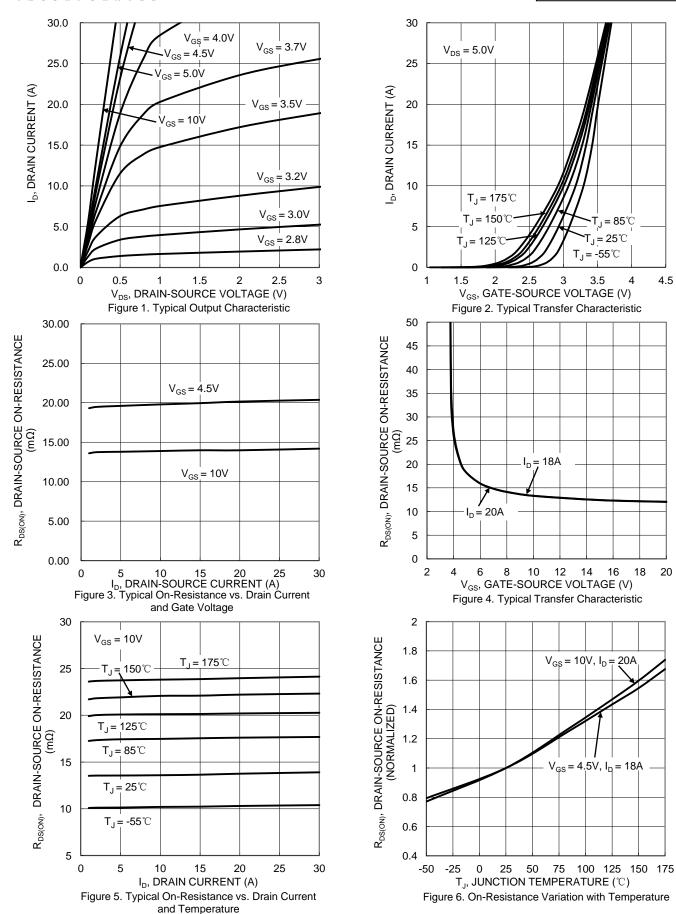
<sup>8.</sup> Thermal resistance from junction to soldering point (on the exposed drain pad).

<sup>9.</sup>  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

<sup>10.</sup> Short duration pulse test used to minimize self-heating effect.

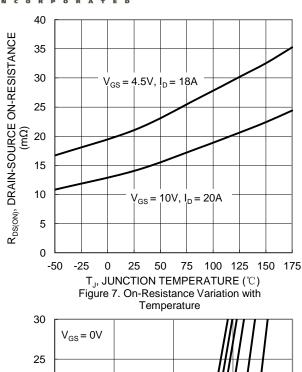
11. Guaranteed by design. Not subject to product testing.

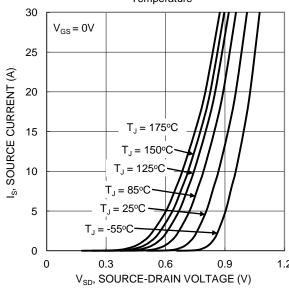


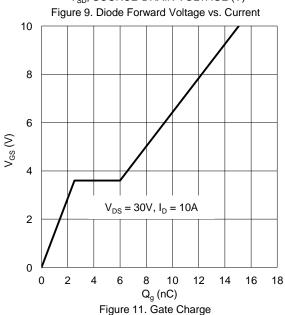


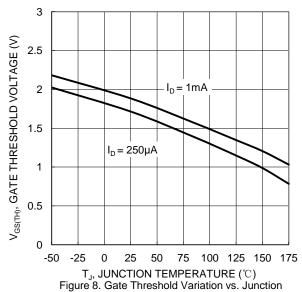


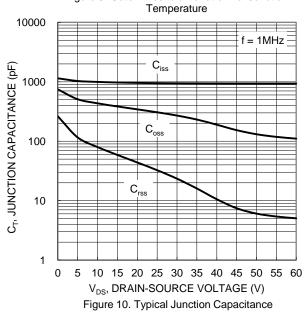


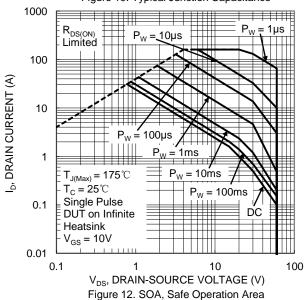














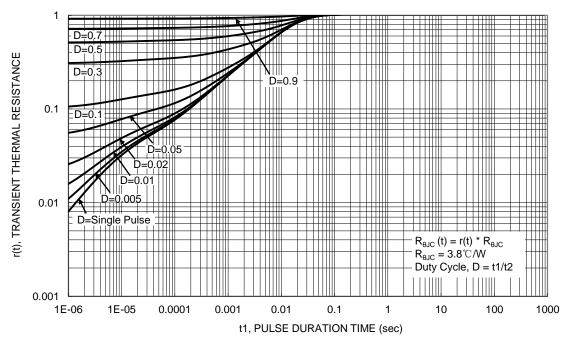


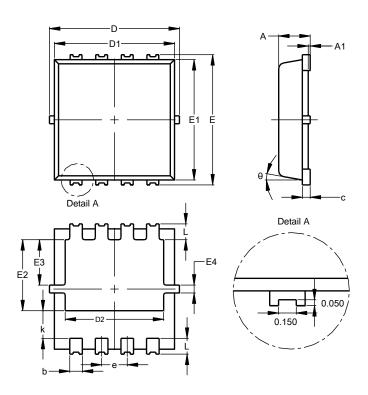
Figure 13. Transient Thermal Resistance



### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8 (SWP) (Type UX)

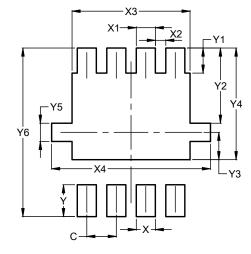


PowerDI3333-8 (SWP)					
(Type UX) ´					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05			
b	0.25	0.40	0.32		
С	0.10	0.25	0.15		
D	3.20	3.40	3.30		
D1	2.95	3.15	3.05		
D2	2.30	2.70	2.50		
Е	3.20	3.40	3.30		
E1	2.95	3.15	3.05		
E2	1.60	2.00	1.80		
E3	0.95	1.35	1.15		
E4	0.10	0.30	0.20		
е	-	-	0.65		
k	0.50	0.90	0.70		
L	0.30	0.50	0.40		
θ	0°	12°	10°		
All Dimensions in mm					

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
Х3	2.600		
X4	3.500		
Υ	0.700		
Y1	0.550		
Y2	1.650		
Y3	0.600		
Y4	2.450		
Y5	0.400		
Y6	3.700		



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